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Details

Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, I ² C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	55
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 12x10b, 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562tabdfp-v3

Table 1.1 Outline of Specifications (4 / 5)

Classification	Module/Function	Description
Communications	CAN module (CAN) (as an optional function)	<ul style="list-style-type: none"> • 1 channel • 32 mailboxes
	Serial peripheral interface (RSPI)	<ul style="list-style-type: none"> • 1 unit • RSPI transfer facility <p>Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPI clock (RSPCK) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines)</p> <p>Capable of handling serial transfer as a master or slave</p> <ul style="list-style-type: none"> • Data formats Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Buffered structure • Double buffers for both transmission and reception
	LIN module (LIN)	<ul style="list-style-type: none"> • 1 channel (LIN master) • Supports revisions 1.3, 2.0, and 2.1 of the LIN protocol
A/D converter	12-bit A/D converter (S12ADA)	<ul style="list-style-type: none"> • 12 bits (2 units x 4 channels) • 12-bit resolution • Conversion time: <ul style="list-style-type: none"> 1.0 μs per channel (in operation with A/D conversion clock ADCLK at 50 MHz) for AVCC = 4.0 to 5.5 V 2.0 μs per channel (in operation with A/D conversion clock ADCLK at 25 MHz) for AVCC0 = 3.0 to 3.6 V • Two basic operating modes Single mode and scan mode • Scan mode <ul style="list-style-type: none"> One-cycle scan mode Continuous scan mode <p>2-channel scan mode (Input ports of the A/D unit are divided into two groups in this mode, and the activation sources are separately selectable for each group.)</p> • Sample-and-hold function A common sample-and-hold circuit for both units is included. Additionally, sample-and-hold circuit for each unit is included. (three channels per unit) • A/D-conversion register settings for each input pin. • Two registers for the result of conversion are provided for a single analog input pin of each unit (AN000 and AN100). • Three ways to start A/D conversion Conversion can be started by software, a conversion start trigger from a timer (MTU3 or GPT), or an external trigger signal. • Functionality for 8- or 10-bit precision output Right-shifting of the results of conversion for output by two or four bits is selectable. • Self-diagnostic function The self-diagnostic function internally generates three analog input voltages (VREFL0, VREFH0 x 1/2, VREFH0). • Amplification of input signals by a programmable gain amplifier (three channels per unit) Amplification rate: 2.0-, 2.5-, 3.077-, 3.636-, 4.0-, 4.444-, 5.0-, 5.714-, 6.667-, 10.0-, or 13.333-times amplification (a total of 11 steps) • Window comparators (three channels per unit)

Table 1.7 List of Pins and Pin Functions (80-Pin LQFP: R5F562TxGDFF) (3 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communication	Interrupt	POE	Debugging
76	AVSS0							
77		P82		MTIC5U	SCK2-B			
78		P81		MTIC5V	TXD2-B			
79		P80		MTIC5W	RXD2-B			
80		P10		MTCLKD-B		IRQ0-A		

2.1 General-Purpose Registers (R0 to R15)

This CPU has sixteen general-purpose registers (R0 to R15). R1 to R15 can be used as data registers or address registers. R0, a general-purpose register, also functions as the stack pointer (SP). The stack pointer is switched to operate as the interrupt stack pointer (ISP) or user stack pointer (USP) by the value of the stack pointer select bit (U) in the processor status word (PSW).

2.2 Control Registers

(1) Interrupt Stack Pointer (ISP)/User Stack Pointer (USP)

The stack pointer (SP) can be either of two types, the interrupt stack pointer (ISP) or the user stack pointer (USP). Whether the stack pointer operates as the ISP or USP depends on the value of the stack pointer select bit (U) in the processor status word (PSW).

Set the ISP or USP to a multiple of four, as this reduces the numbers of cycles required to execute interrupt sequences and instructions entailing stack manipulation.

(2) Interrupt Table Register (INTB)

The interrupt table register (INTB) specifies the address where the relocatable vector table starts.

Set INTB to a multiple of four.

(3) Program Counter (PC)

The program counter (PC) indicates the address of the instruction being executed.

(4) Processor Status Word (PSW)

The processor status word (PSW) indicates results of instruction execution or the state of the CPU.

(5) Backup PC (BPC)

The backup PC (BPC) is provided to speed up response to interrupts.

After a fast interrupt has been generated, the contents of the program counter (PC) are saved in the BPC.

(6) Backup PSW (BPSW)

The backup PSW (BPSW) is provided to speed up response to interrupts.

After a fast interrupt has been generated, the contents of the processor status word (PSW) are saved in the BPSW. The allocation of bits in the BPSW corresponds to that in the PSW.

(7) Fast Interrupt Vector Register (FINTV)

The fast interrupt vector register (FINTV) is provided to speed up response to interrupts.

The FINTV register specifies a branch destination address when a fast interrupt has been generated.

(8) Floating-Point Status Word (FPSW)

The floating-point status word (FPSW) indicates the results of floating-point operations.

When an exception handling enable bit (Ej) enables the exception handling (Ej = 1), the exception cause can be identified by checking the corresponding Cj flag in the exception handling routine. If the exception handling is masked (Ej = 0), the occurrence of exception can be checked by reading the Fj flag at the end of a series of processing. Once the Fj flag has been set to 1, this value is retained until it is cleared to 0 by software (j = X, U, Z, O, or V).

Table 4.1 List of I/O Registers (Address Order) (6 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 71BEh	ICU	DTC activation enable register 190	DTCER190	8	8	2 ICLK
0008 71C0h	ICU	DTC activation enable register 192	DTCER192	8	8	2 ICLK
0008 71C1h	ICU	DTC activation enable register 193	DTCER193	8	8	2 ICLK
0008 71C2h	ICU	DTC activation enable register 194	DTCER194	8	8	2 ICLK
0008 71C3h	ICU	DTC activation enable register 195	DTCER195	8	8	2 ICLK
0008 71C4h	ICU	DTC activation enable register 196	DTCER196	8	8	2 ICLK
0008 71D7h	ICU	DTC activation enable register 215	DTCER215	8	8	2 ICLK
0008 71D8h	ICU	DTC activation enable register 216	DTCER216	8	8	2 ICLK
0008 71DBh	ICU	DTC activation enable register 219	DTCER219	8	8	2 ICLK
0008 71DCh	ICU	DTC activation enable register 220	DTCER220	8	8	2 ICLK
0008 71DFh	ICU	DTC activation enable register 223	DTCER223	8	8	2 ICLK
0008 71E0h	ICU	DTC activation enable register 224	DTCER224	8	8	2 ICLK
0008 71F7h	ICU	DTC activation enable register 247	DTCER247	8	8	2 ICLK
0008 71F8h	ICU	DTC activation enable register 248	DTCER248	8	8	2 ICLK
0008 71FEh	ICU	DTC activation enable register 254	DTCER254	8	8	2 ICLK
0008 7202h	ICU	Interrupt request enable register 02	IER02	8	8	2 ICLK
0008 7203h	ICU	Interrupt request enable register 03	IER03	8	8	2 ICLK
0008 7205h	ICU	Interrupt request enable register 05	IER05	8	8	2 ICLK
0008 7207h	ICU	Interrupt request enable register 07	IER07	8	8	2 ICLK
0008 7208h	ICU	Interrupt request enable register 08	IER08	8	8	2 ICLK
0008 720Ch	ICU	Interrupt request enable register 0C	IER0C	8	8	2 ICLK
0008 720Dh	ICU	Interrupt request enable register 0D	IER0D	8	8	2 ICLK
0008 720Eh	ICU	Interrupt request enable register 0E	IER0E	8	8	2 ICLK
0008 720Fh	ICU	Interrupt request enable register 0F	IER0F	8	8	2 ICLK
0008 7210h	ICU	Interrupt request enable register 10	IER10	8	8	2 ICLK
0008 7211h	ICU	Interrupt request enable register 11	IER11	8	8	2 ICLK
0008 7212h	ICU	Interrupt request enable register 12	IER12	8	8	2 ICLK
0008 7213h	ICU	Interrupt request enable register 13	IER13	8	8	2 ICLK
0008 7215h	ICU	Interrupt request enable register 15	IER15	8	8	2 ICLK
0008 7216h	ICU	Interrupt request enable register 16	IER16	8	8	2 ICLK
0008 7217h	ICU	Interrupt request enable register 17	IER17	8	8	2 ICLK
0008 7218h	ICU	Interrupt request enable register 18	IER18	8	8	2 ICLK
0008 721Ah	ICU	Interrupt request enable register 1A	IER1A	8	8	2 ICLK
0008 721Bh	ICU	Interrupt request enable register 1B	IER1B	8	8	2 ICLK
0008 721Ch	ICU	Interrupt request enable register 1C	IER1C	8	8	2 ICLK
0008 721Eh	ICU	Interrupt request enable register 1E	IER1E	8	8	2 ICLK
0008 721Fh	ICU	Interrupt request enable register 1F	IER1F	8	8	2 ICLK
0008 72E0h	ICU	Software interrupt activation register	SWINTR	8	8	2 ICLK
0008 72F0h	ICU	Fast interrupt set register	FIR	16	16	2 ICLK
0008 7300h	ICU	Interrupt source priority register 00	IPR00	8	8	2 ICLK
0008 7301h	ICU	Interrupt source priority register 01	IPR01	8	8	2 ICLK
0008 7302h	ICU	Interrupt source priority register 02	IPR02	8	8	2 ICLK
0008 7303h	ICU	Interrupt source priority register 03	IPR03	8	8	2 ICLK
0008 7304h	ICU	Interrupt source priority register 04	IPR04	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (7 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 7305h	ICU	Interrupt source priority register 05	IPR05	8	8	2 ICLK
0008 7306h	ICU	Interrupt source priority register 06	IPR06	8	8	2 ICLK
0008 7307h	ICU	Interrupt source priority register 07	IPR07	8	8	2 ICLK
0008 7314h	ICU	Interrupt source priority register 14	IPR14	8	8	2 ICLK
0008 7318h	ICU	Interrupt source priority register 18	IPR18	8	8	2 ICLK
0008 7320h	ICU	Interrupt source priority register 20	IPR20	8	8	2 ICLK
0008 7321h	ICU	Interrupt source priority register 21	IPR21	8	8	2 ICLK
0008 7322h	ICU	Interrupt source priority register 22	IPR22	8	8	2 ICLK
0008 7323h	ICU	Interrupt source priority register 23	IPR23	8	8	2 ICLK
0008 7324h	ICU	Interrupt source priority register 24	IPR24	8	8	2 ICLK
0008 7325h	ICU	Interrupt source priority register 25	IPR25	8	8	2 ICLK
0008 7326h	ICU	Interrupt source priority register 26	IPR26	8	8	2 ICLK
0008 7327h	ICU	Interrupt source priority register 27	IPR27	8	8	2 ICLK
0008 7340h	ICU	Interrupt source priority register 40	IPR40	8	8	2 ICLK
0008 7344h	ICU	Interrupt source priority register 44	IPR44	8	8	2 ICLK
0008 7348h	ICU	Interrupt source priority register 48	IPR48	8	8	2 ICLK
0008 7349h	ICU	Interrupt source priority register 49	IPR49	8	8	2 ICLK
0008 7351h	ICU	Interrupt source priority register 51	IPR51	8	8	2 ICLK
0008 7352h	ICU	Interrupt source priority register 52	IPR52	8	8	2 ICLK
0008 7353h	ICU	Interrupt source priority register 53	IPR53	8	8	2 ICLK
0008 7354h	ICU	Interrupt source priority register 54	IPR54	8	8	2 ICLK
0008 7355h	ICU	Interrupt source priority register 55	IPR55	8	8	2 ICLK
0008 7356h	ICU	Interrupt source priority register 56	IPR56	8	8	2 ICLK
0008 7357h	ICU	Interrupt source priority register 57	IPR57	8	8	2 ICLK
0008 7358h	ICU	Interrupt source priority register 58	IPR58	8	8	2 ICLK
0008 7359h	ICU	Interrupt source priority register 59	IPR59	8	8	2 ICLK
0008 735Ah	ICU	Interrupt source priority register 5A	IPR5A	8	8	2 ICLK
0008 735Bh	ICU	Interrupt source priority register 5B	IPR5B	8	8	2 ICLK
0008 735Ch	ICU	Interrupt source priority register 5C	IPR5C	8	8	2 ICLK
0008 735Dh	ICU	Interrupt source priority register 5D	IPR5D	8	8	2 ICLK
0008 735Eh	ICU	Interrupt source priority register 5E	IPR5E	8	8	2 ICLK
0008 735Fh	ICU	Interrupt source priority register 5F	IPR5F	8	8	2 ICLK
0008 7360h	ICU	Interrupt source priority register 60	IPR60	8	8	2 ICLK
0008 7367h	ICU	Interrupt source priority register 67	IPR67	8	8	2 ICLK
0008 7368h	ICU	Interrupt source priority register 68	IPR68	8	8	2 ICLK
0008 7369h	ICU	Interrupt source priority register 69	IPR69	8	8	2 ICLK
0008 736Ah	ICU	Interrupt source priority register 6A	IPR6A	8	8	2 ICLK
0008 736Bh	ICU	Interrupt source priority register 6B	IPR6B	8	8	2 ICLK
0008 736Ch	ICU	Interrupt source priority register 6C	IPR6C	8	8	2 ICLK
0008 736Dh	ICU	Interrupt source priority register 6D	IPR6D	8	8	2 ICLK
0008 736Eh	ICU	Interrupt source priority register 6E	IPR6E	8	8	2 ICLK
0008 736Fh	ICU	Interrupt source priority register 6F	IPR6F	8	8	2 ICLK
0008 7380h	ICU	Interrupt source priority register 80	IPR80	8	8	2 ICLK
0008 7381h	ICU	Interrupt source priority register 81	IPR81	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (10 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 8250h	SCI2	Serial mode register	SMR ^{*1}	8	8	2, 3 PCLK ^{*3}
0008 8251h	SCI2	Bit rate register	BRR	8	8	2, 3 PCLK ^{*3}
0008 8252h	SCI2	Serial control register	SCR ^{*1}	8	8	2, 3 PCLK ^{*3}
0008 8253h	SCI2	Transmit data register	TDR	8	8	2, 3 PCLK ^{*3}
0008 8254h	SCI2	Serial status register	SSR ^{*1}	8	8	2, 3 PCLK ^{*3}
0008 8255h	SCI2	Receive data register	RDR	8	8	2, 3 PCLK ^{*3}
0008 8256h	SCI2	Smart card mode register	SCMR	8	8	2, 3 PCLK ^{*3}
0008 8257h	SCI2	Serial extended mode register	SEMR	8	8	2, 3 PCLK ^{*3}
0008 8250h	SMCI2	Serial mode register	SMR ^{*1}	8	8	2, 3 PCLK ^{*3}
0008 8251h	SMCI2	Bit rate register	BRR	8	8	2, 3 PCLK ^{*3}
0008 8252h	SMCI2	Serial control register	SCR ^{*1}	8	8	2, 3 PCLK ^{*3}
0008 8253h	SMCI2	Transmit data register	TDR	8	8	2, 3 PCLK ^{*3}
0008 8254h	SMCI2	Serial status register	SSR ^{*1}	8	8	2, 3 PCLK ^{*3}
0008 8255h	SMCI2	Receive data register	RDR	8	8	2, 3 PCLK ^{*3}
0008 8256h	SMCI2	Smart card mode register	SCMR	8	8	2, 3 PCLK ^{*3}
0008 8280h	CRC	CRC control register	CRCCR	8	8	2, 3 PCLK ^{*3}
0008 8281h	CRC	CRC data input register	CRCDIR	8	8	2, 3 PCLK ^{*3}
0008 8282h	CRC	CRC data output register	CRCDOR	16	16	2, 3 PCLK ^{*3}
0008 8300h	RIIC	I ² C bus control register 1	ICCR1	8	8	2, 3 PCLK ^{*3}
0008 8301h	RIIC	I ² C bus control register 2	ICCR2	8	8	2, 3 PCLK ^{*3}
0008 8302h	RIIC	I ² C bus mode register 1	ICMR1	8	8	2, 3 PCLK ^{*3}
0008 8303h	RIIC	I ² C bus mode register 2	ICMR2	8	8	2, 3 PCLK ^{*3}
0008 8304h	RIIC	I ² C bus mode register 3	ICMR3	8	8	2, 3 PCLK ^{*3}
0008 8305h	RIIC	I ² C bus function enable register	ICFER	8	8	2, 3 PCLK ^{*3}
0008 8306h	RIIC	I ² C bus status enable register	ICSER	8	8	2, 3 PCLK ^{*3}
0008 8307h	RIIC	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLK ^{*3}
0008 8308h	RIIC	I ² C bus status register 1	ICSR1	8	8	2, 3 PCLK ^{*3}
0008 8309h	RIIC	I ² C bus status register 2	ICSR2	8	8	2, 3 PCLK ^{*3}
0008 830Ah	RIIC	Slave address register L0	SARL0	8	8	2, 3 PCLK ^{*3}
0008 830Ah	RIIC	Internal counter L for timeout	TMOCNTL	8	8	2, 3 PCLK ^{*3}
0008 830Bh	RIIC	Slave address register U0	SARU0	8	8	2, 3 PCLK ^{*3}
0008 830Bh	RIIC	Internal counter U for timeout	TMOCNTU	8	8	2, 3 PCLK ^{*3}
0008 830Bh	RIIC	Slave address register U0	SARU0	8	8	2, 3 PCLK ^{*3}
0008 830Ch	RIIC	Slave address register L1	SARL1	8	8	2, 3 PCLK ^{*3}
0008 830Dh	RIIC	Slave address register U1	SARU1	8	8	2, 3 PCLK ^{*3}
0008 830Eh	RIIC	Slave address register L2	SARL2	8	8	2, 3 PCLK ^{*3}
0008 830Fh	RIIC	Slave address register U2	SARU2	8	8	2, 3 PCLK ^{*3}
0008 8310h	RIIC	I ² C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLK ^{*3}
0008 8311h	RIIC	I ² C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLK ^{*3}
0008 8312h	RIIC	I ² C bus transmit data register	ICDRT	8	8	2, 3 PCLK ^{*3}
0008 8313h	RIIC	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLK ^{*3}
0008 8380h	RSPI	RSPI control register	SPCR	8	8	2, 3 PCLK ^{*3}
0008 8381h	RSPI	RSPI slave select polarity register	SSLP	8	8	2, 3 PCLK ^{*3}
0008 8382h	RSPI	RSPI pin control register	SPPCR	8	8	2, 3 PCLK ^{*3}

Table 4.1 List of I/O Registers (Address Order) (21 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
000C 2116h	GPT0	General PWM timer compare capture register D	GTCCRD	16	16, 32	3 to 5 ICLK*4
000C 2118h	GPT0	General PWM timer compare capture register E	GTCCRE	16	16, 32	3 to 5 ICLK*4
000C 211Ah	GPT0	General PWM timer compare capture register F	GTCCRF	16	16, 32	3 to 5 ICLK*4
000C 211Ch	GPT0	General PWM timer cycle setting register	GTPR	16	16, 32	3 to 5 ICLK*4
000C 211Eh	GPT0	General PWM timer cycle setting buffer register	GTPBR	16	16, 32	3 to 5 ICLK*4
000C 2120h	GPT0	General PWM timer cycle setting double-buffer register	GTPDBR	16	16, 32	3 to 5 ICLK*4
000C 2124h	GPT0	A/D converter start request timing register A	GTADTRA	16	16, 32	3 to 5 ICLK*4
000C 2126h	GPT0	A/D converter start request timing buffer register A	GTADTBRA	16	16, 32	3 to 5 ICLK*4
000C 2128h	GPT0	A/D converter start request timing double-buffer register A	GTADTDBRA	16	16, 32	3 to 5 ICLK*4
000C 212Ch	GPT0	A/D converter start request timing register B	GTADTRB	16	16, 32	3 to 5 ICLK*4
000C 212Eh	GPT0	A/D converter start request timing buffer register B	GTADTBRB	16	16, 32	3 to 5 ICLK*4
000C 2130h	GPT0	A/D converter start request timing double-buffer register B	GTADTDBRB	16	16, 32	3 to 5 ICLK*4
000C 2134h	GPT0	General PWM timer output negate control register	GTONCR	16	16, 32	3 to 5 ICLK*4
000C 2136h	GPT0	General PWM timer dead time control register	GTDTCR	16	16, 32	3 to 5 ICLK*4
000C 2138h	GPT0	General PWM timer dead time value register	GTDVU	16	16, 32	3 to 5 ICLK*4
000C 213Ah	GPT0	General PWM timer dead time value register	GTDVD	16	16, 32	3 to 5 ICLK*4
000C 213Ch	GPT0	General PWM timer dead time buffer register	GTDBU	16	16, 32	3 to 5 ICLK*4
000C 213Eh	GPT0	General PWM timer dead time buffer register	GTDBD	16	16, 32	3 to 5 ICLK*4
000C 2140h	GPT0	General PWM timer output protection function status register	GTSOS	16	16, 32	3 to 5 ICLK*4
000C 2142h	GPT0	General PWM timer output protection function temporary release register	GTSOTR	16	16, 32	3 to 5 ICLK*4
000C 2180h	GPT1	General PWM timer I/O control register	GTIOR	16	8, 16, 32	3 to 5 ICLK*4
000C 2182h	GPT1	General PWM timer interrupt output setting register	GTINTAD	16	8, 16, 32	3 to 5 ICLK*4
000C 2184h	GPT1	General PWM timer control register	GTCR	16	8, 16, 32	3 to 5 ICLK*4
000C 2186h	GPT1	General PWM timer buffer enable register	GTBER	16	8, 16, 32	3 to 5 ICLK*4
000C 2188h	GPT1	General PWM timer count direction register	GTUDC	16	8, 16, 32	3 to 5 ICLK*4
000C 218Ah	GPT1	General PWM timer interrupt and A/D converter start request skipping setting register	GTITC	16	8, 16, 32	3 to 5 ICLK*4
000C 218Ch	GPT1	General PWM timer status register	GTST	16	8, 16, 32	3 to 5 ICLK*4
000C 218Eh	GPT1	General PWM timer counter	GTCNT	16	16	3 to 5 ICLK*4
000C 2190h	GPT1	General PWM timer compare capture register A	GTCCRA	16	16, 32	3 to 5 ICLK*4
000C 2192h	GPT1	General PWM timer compare capture register B	GTCCRB	16	16, 32	3 to 5 ICLK*4
000C 2194h	GPT1	General PWM timer compare capture register C	GTCCRC	16	16, 32	3 to 5 ICLK*4
000C 2196h	GPT1	General PWM timer compare capture register D	GTCCRD	16	16, 32	3 to 5 ICLK*4
000C 2198h	GPT1	General PWM timer compare capture register E	GTCCRE	16	16, 32	3 to 5 ICLK*4
000C 219Ah	GPT1	General PWM timer compare capture register F	GTCCRF	16	16, 32	3 to 5 ICLK*4
000C 219Ch	GPT1	General PWM timer cycle setting register	GTPR	16	16, 32	3 to 5 ICLK*4
000C 219Eh	GPT1	General PWM timer cycle setting buffer register	GTPBR	16	16, 32	3 to 5 ICLK*4

Table 4.1 List of I/O Registers (Address Order) (25 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
007F FFBAh	FLASH	FCU command register	FCMDR	16	16	2, 3 PCLK ^{*3}
007F FFC8h	FLASH	FCU processing switching register	FCPSR	16	16	2, 3 PCLK ^{*3}
007F FFCAh	FLASH	Data flash blank check control register	DFLBCCNT	16	16	2, 3 PCLK ^{*3}
007F FFCCh	FLASH	Flash P/E status register	FPESTAT	16	16	2, 3 PCLK ^{*3}
007F FFCEh	FLASH	Data flash blank check status register	DFLBCSTAT	16	16	2, 3 PCLK ^{*3}
007F FFE8h	FLASH	Peripheral clock notification register	PCKAR	16	16	2, 3 PCLK ^{*3}

Note 1. This register is not supported by the 100-pin LQFP version.

Note 2. This register is not supported by the product without the CAN function.

Note 3. The number of access states depends on the number of divided cycles for clock synchronization (0 to 1 PCLK).

Note 4. Reading the registers takes 3 cycles of ICLK and writing to the registers takes 5 cycles of ICLK.

Table 4.2 List of I/O Registers (Bit Order) (3 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
MPU	RSPAGE7				RSPN[27:0]				
					RSPN[27:0]				
					RSPN[27:0]				
				RSPN[27:0]					
MPU	REPAGE7				REPN[27:0]				
					REPN[27:0]				
					REPN[27:0]				
				REPN[27:0]		UAC[2:0]			V
MPU	MPEN	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	MPEN
MPU	MPBAC	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	UBAC[2:0]	—	—	—
MPU	MPECLR	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	CLR
MPU	MPESTS	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	—
		—	—	—	—	DRW	DA	IA	—
MPU	MPDEA				DEA[31:0]				
					DEA[31:0]				
					DEA[31:0]				
					DEA[31:0]				
MPU	MPSA				SA[31:0]				
					SA[31:0]				
					SA[31:0]				
					SA[31:0]				
MPU	MPOPS	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	S
MPU	MPOPI	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	INV
MPU	MHITI	—	—	—	—	HITI[7:0]			
		—	—	—	—	—	—	—	—
		—	—	—	—	UHACI[2:0]	—	—	—
MPU	MHITD	—	—	—	—	HITD[7:0]			
		—	—	—	—	—	—	—	—
		—	—	—	—	UHACD[2:0]	—	—	—
ICU	IR016	—	—	—	—	—	—	—	IR
ICU	IR021	—	—	—	—	—	—	—	IR
ICU	IR023	—	—	—	—	—	—	—	IR
ICU	IR027	—	—	—	—	—	—	—	IR
ICU	IR028	—	—	—	—	—	—	—	IR
ICU	IR029	—	—	—	—	—	—	—	IR
ICU	IR030	—	—	—	—	—	—	—	IR
ICU	IR031	—	—	—	—	—	—	—	IR

Table 4.2 List of I/O Registers (Bit Order) (4 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
ICU	IR044	—	—	—	—	—	—	—	IR
ICU	IR045	—	—	—	—	—	—	—	IR
ICU	IR046	—	—	—	—	—	—	—	IR
ICU	IR047	—	—	—	—	—	—	—	IR
ICU	IR056	—	—	—	—	—	—	—	IR
ICU	IR057	—	—	—	—	—	—	—	IR
ICU	IR058	—	—	—	—	—	—	—	IR
ICU	IR059	—	—	—	—	—	—	—	IR
ICU	IR060	—	—	—	—	—	—	—	IR
ICU	IR064	—	—	—	—	—	—	—	IR
ICU	IR065	—	—	—	—	—	—	—	IR
ICU	IR066	—	—	—	—	—	—	—	IR
ICU	IR067	—	—	—	—	—	—	—	IR
ICU	IR068	—	—	—	—	—	—	—	IR
ICU	IR069	—	—	—	—	—	—	—	IR
ICU	IR070	—	—	—	—	—	—	—	IR
ICU	IR071	—	—	—	—	—	—	—	IR
ICU	IR096	—	—	—	—	—	—	—	IR
ICU	IR098	—	—	—	—	—	—	—	IR
ICU	IR102	—	—	—	—	—	—	—	IR
ICU	IR103	—	—	—	—	—	—	—	IR
ICU	IR106	—	—	—	—	—	—	—	IR
ICU	IR114	—	—	—	—	—	—	—	IR
ICU	IR115	—	—	—	—	—	—	—	IR
ICU	IR116	—	—	—	—	—	—	—	IR
ICU	IR117	—	—	—	—	—	—	—	IR
ICU	IR118	—	—	—	—	—	—	—	IR
ICU	IR119	—	—	—	—	—	—	—	IR
ICU	IR120	—	—	—	—	—	—	—	IR
ICU	IR121	—	—	—	—	—	—	—	IR
ICU	IR122	—	—	—	—	—	—	—	IR
ICU	IR123	—	—	—	—	—	—	—	IR
ICU	IR124	—	—	—	—	—	—	—	IR
ICU	IR125	—	—	—	—	—	—	—	IR
ICU	IR126	—	—	—	—	—	—	—	IR
ICU	IR127	—	—	—	—	—	—	—	IR
ICU	IR128	—	—	—	—	—	—	—	IR
ICU	IR129	—	—	—	—	—	—	—	IR
ICU	IR130	—	—	—	—	—	—	—	IR
ICU	IR131	—	—	—	—	—	—	—	IR
ICU	IR132	—	—	—	—	—	—	—	IR
ICU	IR133	—	—	—	—	—	—	—	IR
ICU	IR134	—	—	—	—	—	—	—	IR
ICU	IR135	—	—	—	—	—	—	—	IR
ICU	IR136	—	—	—	—	—	—	—	IR
ICU	IR137	—	—	—	—	—	—	—	IR
ICU	IR138	—	—	—	—	—	—	—	IR
ICU	IR139	—	—	—	—	—	—	—	IR
ICU	IR140	—	—	—	—	—	—	—	IR
ICU	IR141	—	—	—	—	—	—	—	IR
ICU	IR142	—	—	—	—	—	—	—	IR
ICU	IR143	—	—	—	—	—	—	—	IR

Table 4.2 List of I/O Registers (Bit Order) (29 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
GPT2	GTDLYCR	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLYEN	DLYRST	DLLEN
GPT3	GTDLYCR	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLYEN	DLYRST	DLLEN
GPT0	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT0	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT1	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT1	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT2	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT2	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT3	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT3	GTDLYRB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT0	GTDLYFA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT0	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT1	GTDLYFA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT1	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT2	GTDLYRA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT2	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT3	GTDLYFA	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
GPT3	GTDLYFB	—	—	—	—	—	—	—	—
		—	—	—	—	—	DLY[4:0]		
FLASH	FMODR	—	—	—	FRDMD	—	—	—	—
FLASH	FASTAT	ROMAE	—	CMDLK	DFLAE	—	DFLRPE	DFLWPE	
FLASH	FAEINT	ROMAEIE	—	CMDLKIE	DFLAEIE	—	DFLRPEIE	DFLWPEIE	
FLASH	FRDYIE	—	—	—	—	—	—	FRDYIE	
FLASH	DFLRE0				KEY[7:0]				
		DBRE07	DBRE06	DBRE05	DBRE04	DBRE03	DBRE02	DBRE01	DBRE00
FLASH	DFLRE1				KEY[7:0]				
		DBRE15	DBRE14	DBRE13	DBRE12	DBRE11	DBRE10	DBRE09	DBRE08
FLASH	DFLWE0				KEY[7:0]				
		DBWE07	DBWE06	DBWE05	DBWE04	DBWE03	DBWE02	DBWE01	DBWE00
FLASH	DFLWE1				KEY[7:0]				
		DBWE15	DBWE14	DBWE13	DBWE12	DBWE11	DBWE10	DBWE09	DBWE08
FLASH	FCURAME				KEY[7:0]				
		—	—	—	—	—	—	—	FCRME

Table 4.2 List of I/O Registers (Bit Order) (30 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
FLASH	FSTATR0	FRDY	ILGLERR	ERSERR	PRGERR	SUSRDY	—	ERSSPD	PRGSPD
FLASH	FSTATR1	FCUERR	—	—	FLOCKST	—	—	—	—
FLASH	FENTRYR					FEKEY[7:0]			
		FENTRYD	—	—	—	—	—	—	FENTRY0
FLASH	FPROTR					FPKEY[7:0]			
		—	—	—	—	—	—	—	FPROTCN
FLASH	FRESETR					FRKEY[7:0]			
		—	—	—	—	—	—	—	FRESET
FLASH	FCMDR					CMDR[7:0]			
						PCMDR[7:0]			
FLASH	FCPSR	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	ESUSPMD
FLASH	DFLBCCNT	—	—	—	—	—		BCADR[7:0]	
					BCADDR[7:0]			—	BCSIZE
FLASH	FPESTAT	—	—	—	—	—	—	—	—
						PEERRST[7:0]			
FLASH	DFLBCSTAT	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	BCST
FLASH	PCKAR	—	—	—	—	—	—	—	—
						PCKA[7:0]			

Note: • In this, the I/O port related registers (0008 C001h to 0008 C116h) indicate the bit configuration of the 112-pin LQFP version. As the configuration of registers and bits differs depending on a package, see section 14, I/O Ports, for details in the User's manual: Hardware.

Note 1. This shows the bit configuration when ADDPR.DPSEL = 0 and ADDPR.DPPRC = 0 (The value has 10-bit accuracy and is padded at the LSB end).

Note 2. This shows the bit configuration when ADCER.ADRFMT = 0 (aligned to the LSB end) and ADCER.ADPRC[1:0] = 00b. For details, refer to section 28, 12-Bit A/D Converter (S12ADA) in the User's manual: Hardware.

Note 3. This function is not supported by the product without the CAN function.

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Item	Symbol	Value	Unit
Power supply voltage	V _C PLLV _C	-0.3 to +6.5	V
Input voltage (except for ports 4 to 6)	V _{IN}	-0.3 to V _C +0.3	V
Input voltage (port 4)	V _{IN}	-0.3 to AVCC0+0.3	V
Input voltage (ports 5 and 6)	V _{IN}	-0.3 to AVCC+0.3	V
Analog power supply voltage	AVCC0, AVCC ^{*1}	-0.3 to +6.5	V
Reference power supply voltage	VREFH0 ^{*1}	-0.3 to AVCC0+0.3	V
	VREF ^{*1}	-0.3 to AVCC+0.3	
Analog input voltage (port 4)	V _{AN}	-0.3 to AVCC0+0.3	V
Analog input voltage (ports 5 and 6)	V _{AN}	-0.3 to AVCC+0.3	V
Operating temperature	T _{opr}	-40 to +85	°C
	T _{opr}	-40 to +105	°C
Storage temperature	T _{stg}	-55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

Note 1. Do not leave the AVCC0, VREFH0, VREFL0, AVSS0, AVCC, VREF, and AVSS pins open circuit even if the A/D converter is not to be used.

- When the 12-bit converter is not in use:
Connect the AVCC0 pin to AVCC (or VCC for a 64-pin product), the VREFH0 pin to VREF (or AVCC or VCC for an 80- or 64-pin product, respectively), and the AVSS0 and VREFL0 pins to VSS.
- When the 10-bit converter is not in use:
Connect the AVCC pin to AVCC0, the VREF pin to VREFH0, and the AVSS pin to AVSS0.
- When neither the 10- nor the 12-bit converter is in use:
Connect the AVCC0, VREFH0, AVCC, and VREF pins to VCC, and the AVSS0, VREFL0, and AVSS pins to VSS.

5.3.2 Control Signal Timing

Table 5.8 Control Signal Timing

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Max.	Unit	Test Conditions
RES# pulse width (except for programming or erasure of the ROM or data-flash memory or blank checking of the data-flash memory ^{*1})	t_{RESW}^{*2}	20	-	t_{Icyc}^{*4}	Figure 5.5
		1.5	-	μs	
Internal reset time ^{*3}	t_{RESW2}	35	-	μs	
NMI pulse width	t_{NMIW}	200	-	ns	Figure 5.6
IRQ pulse width	t_{IRQW}	200	-	ns	Figure 5.7

Note 1. For a reset by the signal on the RES# pin during programming or erasure of the ROM or data-flash memory or during blank checking of the data-flash memory, see section 31.12, Usage Notes in section 31, ROM (Flash Memory for Code Storage) in the User's manual: Hardware.

Note 2. Both the time and the number of cycles should satisfy the specifications.

Note 3. This is to specify the FCU reset.

Note 4. ICLK cycles.

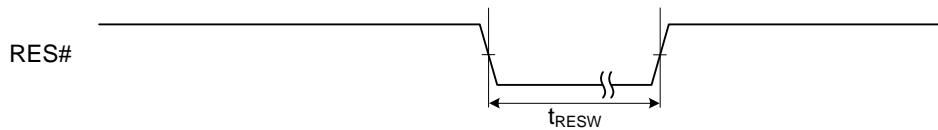


Figure 5.5 Reset Input Timing

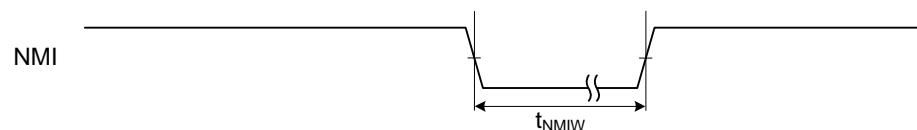


Figure 5.6 NMI Interrupt Input Timing

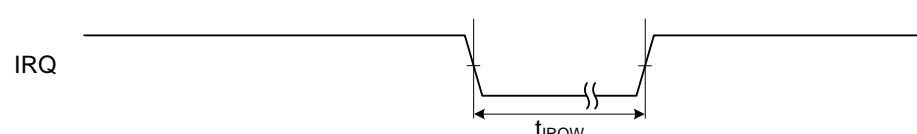


Figure 5.7 IRQ Interrupt Input Timing

Table 5.17 Characteristics of the Programmable Gain Amplifier

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Analog input capacitance	Cin	-	-	6	pF	
Input offset voltage	Voff	-	-	8	mV	
Input voltage range (Vin)	Gain × 2.000	Vin	0.050 × AVcc	-	0.450 × AVcc	V
	Gain × 2.500		0.047 × AVcc	-	0.360 × AVcc	
	Gain × 3.077		0.045 × AVcc	-	0.292 × AVcc	
	Gain × 3.636		0.042 × AVcc	-	0.247 × AVcc	
	Gain × 4.000		0.040 × AVcc	-	0.212 × AVcc	
	Gain × 4.444		0.036 × AVcc	-	0.191 × AVcc	
	Gain × 5.000		0.033 × AVcc	-	0.170 × AVcc	
	Gain × 5.714		0.031 × AVcc	-	0.148 × AVcc	
	Gain × 6.667		0.029 × AVcc	-	0.127 × AVcc	
	Gain × 10.000		0.025 × AVcc	-	0.08 × AVcc	
	Gain × 13.333		0.023 × AVcc	-	0.06 × AVcc	
Slew rate	SR	10	-	-	V/μs	
Gain error	Gain × 2.000	-	-	-	1	%
	Gain × 2.500		-	-	1	
	Gain × 3.077		-	-	1	
	Gain × 3.636		-	-	1.5	
	Gain × 4.000		-	-	1.5	
	Gain × 4.444		-	-	2	
	Gain × 5.000		-	-	2	
	Gain × 5.714		-	-	2	
	Gain × 6.667		-	-	3	
	Gain × 10.000		-	-	4	
	Gain × 13.333		-	-	4	

5.5 Power-on Reset Circuit, Voltage Detection Circuit Characteristics

Table 5.19 Power-on Reset Circuit, Voltage Detection Circuit Characteristics

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 and 2.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	V _{POR}	2.48	2.60	2.72	V	Figure 5.20
	V _{det1}	2.68	2.80	2.92		Figure 5.21
	V _{det2}	2.98	3.10	3.22		Figure 5.22
Internal reset time	t _{POR}	20	35	50	ms	Figure 5.21 and Figure 5.22
Min. VCC down time *1	t _{VOFF}	200	-	-	us	Figure 5.20 to Figure 5.22
Reply delay time	t _{det}	-	-	200	us	

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V

AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Ta = Topr

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	V _{POR}	3.70	3.90	4.10	V	Figure 5.20
	V _{det1}	3.95	4.15	4.35		Figure 5.21
	V _{det2}	4.40	4.60	4.80		Figure 5.22
Internal reset time	t _{POR}	20	35	50	ms	Figure 5.21 and Figure 5.22
Min. VCC down time *1	t _{VOFF}	200	-	-	us	Figure 5.20 to Figure 5.22
Reply delay time	t _{det}	-	-	200	us	

Note 1. The power-off time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{det1}, and V_{det2} for the POR/ LVD.

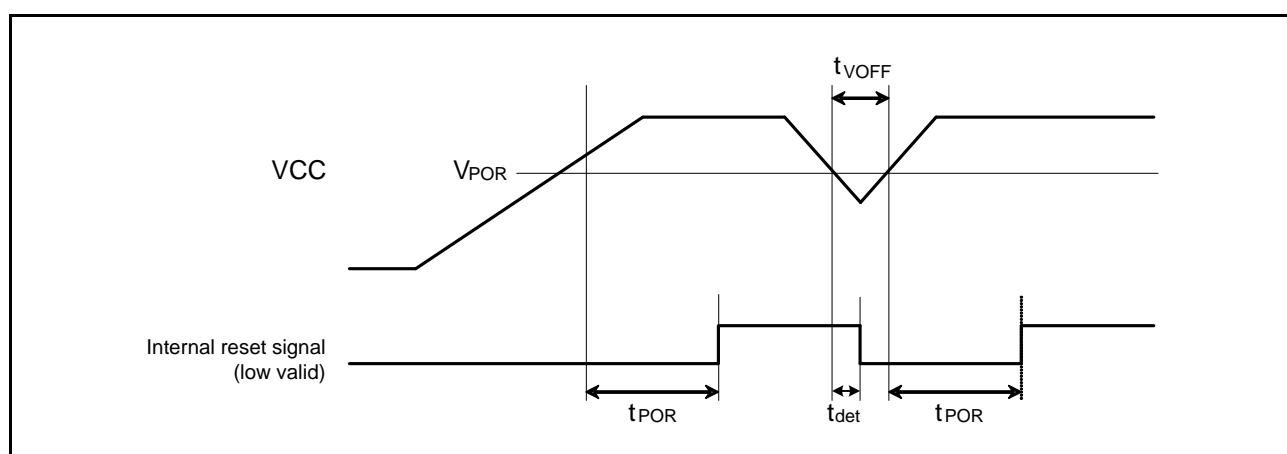


Figure 5.20 Power-on Reset Timing

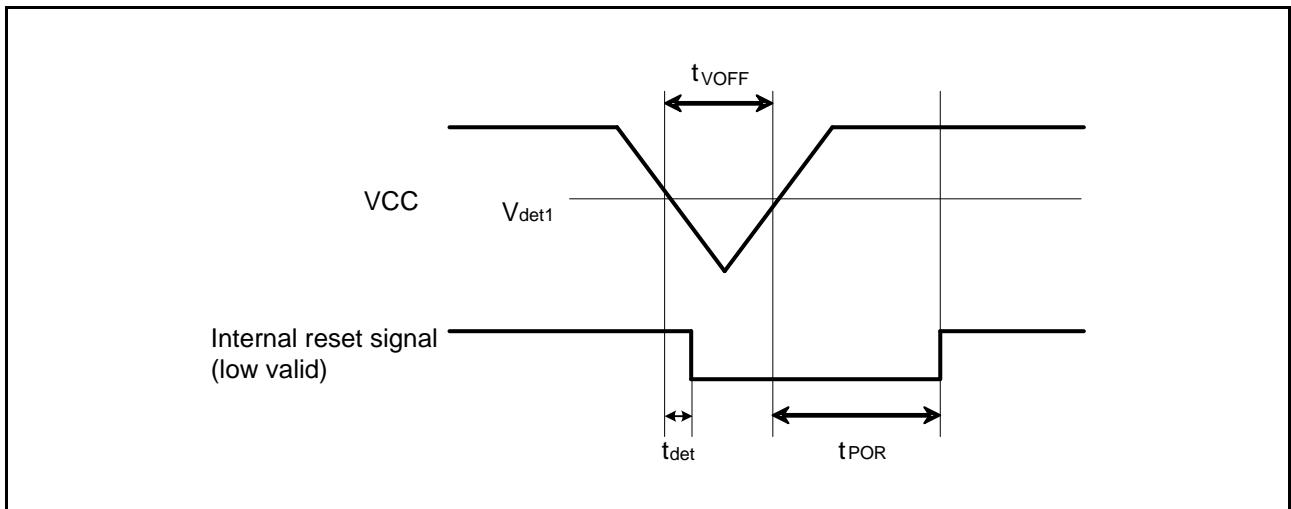


Figure 5.21 Voltage Detection Circuit Timing (Vdet1)

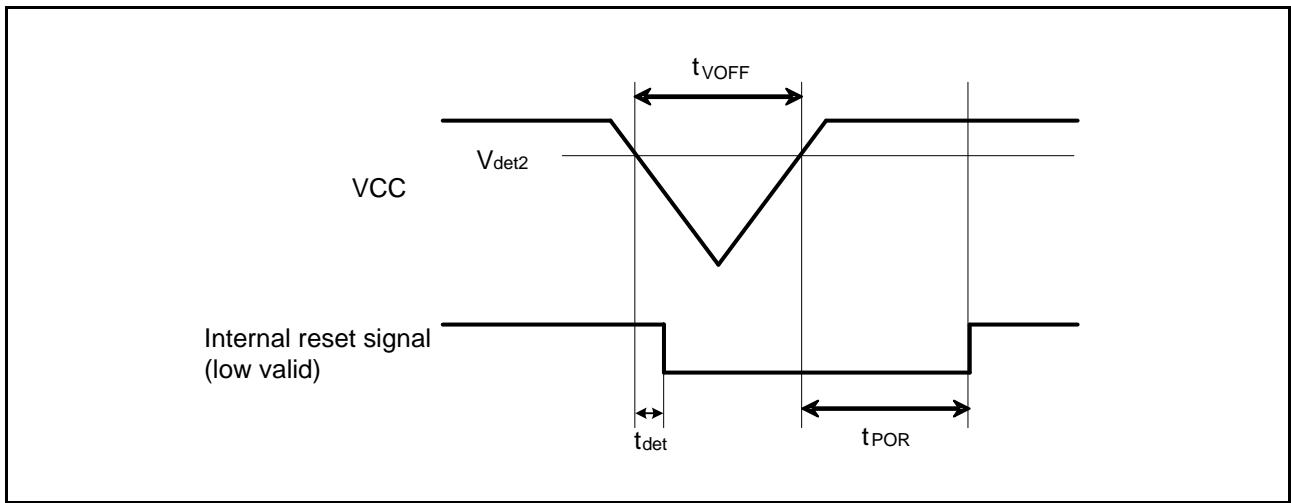


Figure 5.22 Voltage Detection Circuit Timing (Vdet2)

5.6 Oscillation Stop Detection Timing

Table 5.20 Oscillation Stop Detection Circuit Characteristics

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Detection time	tdr	-	-	1.0	ms	Figure 5.23
Internal oscillation frequency when oscillation stop is detected	f _{MAIN}	0.5	-	7.0	MHz	

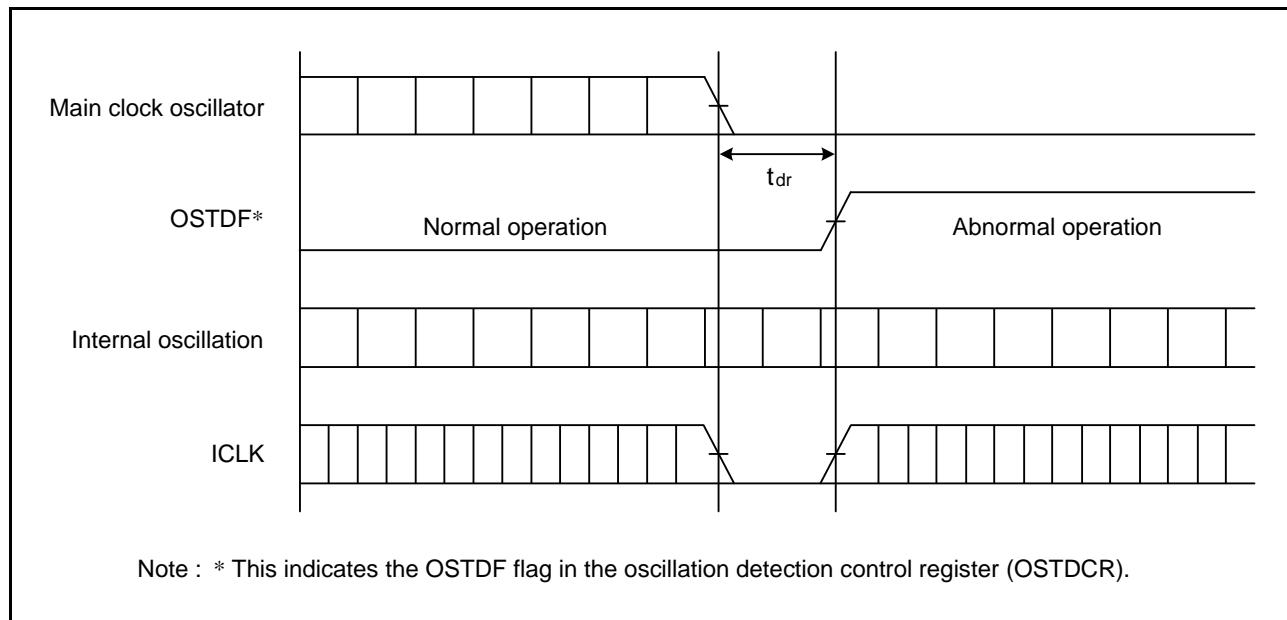


Figure 5.23 Oscillation Stop Detection Timing

5.7 ROM (Flash Memory for Code Storage) Characteristics

Table 5.21 ROM (Flash Memory for Code Storage) Characteristics (1)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Temperature range for the programming/erasure operation:

T_a = Topr. T_a is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Rewrite/erase cycle *1	N _{PEC}	1000	—	—	Times	
Data hold time	t _{DRP}	30*2	—	—	Year	T _a = +85°C

Note 1. Definition of rewrite/erase cycle:

The rewrite/erase cycle is the number of erasing for each block. When the rewrite/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 256-byte writing is performed 16 times for different addresses in 4-Kbyte block and then the entire block is erased, the rewrite/erase cycle is counted as one. However, writing to the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. The value is obtained from the reliability test.

Table 5.22 ROM (Flash Memory for Code Storage) Characteristics (2)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Temperature range for the programming/erasure operation:

T_a = Topr. T_a is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Programming time	256 bytes	t _{P256}	—	2	12	ms
	4 Kbytes	t _{P4K}	—	23	50	ms
	16 Kbytes	t _{P16K}	—	90	200	ms
	256 byte	t _{P256}	—	2.4	14.4	ms
	4 Kbytes	t _{P4K}	—	27.6	60	ms
	16 Kbytes	t _{P16K}	—	108	240	ms
Erasure time	4 Kbytes	t _{E4K}	—	25	60	ms
	16 Kbytes	t _{E16K}	—	100	240	ms
	4 Kbytes	t _{E4K}	—	30	72	ms
	16 Kbytes	t _{E16K}	—	120	288	ms
Suspend delay time during writing	t _{SPD}	—	—	120	μs	Figure 5.24 PCLK = 50 MHz
First suspend delay time during erasing (in suspend priority mode)	t _{SESD1}	—	—	120	μs	
Second suspend delay time during erasing (in suspend priority mode)	t _{SESD2}	—	—	1.7	ms	
Suspend delay time during erasing (in erasure priority mode)	t _{SEED}	—	—	1.7	ms	

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